

MOS FIELD EFFECT TRANSISTOR 2SK3297

SWITCHING N-CHANNEL POWER MOS FET INDUSTRIAL USE

DESCRIPTION

The 2SK3297 is N-channel DMOS FET device that features a low gate charge and excellent switching characteristics, and designed for high voltage applications such as switching power supply, AC adapter.

ORDERING INFORMATION

PART NUMBER	PACKAGE
2SK3297	Isolated TO-220



•Low gate charge

Qg = 18 nC TYP. (VDD = 450 V, Vgs = 10 V, ID = 5.0 A)

•Gate voltage rating ±30 V

•Low on-state resistance

- $R_{\text{DS(ON)}}$ = 1.6 Ω MAX. (Vgs = 10 V, Id = 2.5 V)
- •Avalanche capability ratings
- •Isolated TO-220 package

ABSOLUTE MAXIMUM RATINGS (TA = 25°C)

Drain to Source Voltage (Vgs = 0 V)	VDSS	600	V
Gate to Source Voltage ($V_{DS} = 0 V$)	Vgss	±30	V
Drain Current(DC) (Tc = 25°C)	ID(DC)	±5.0	А
Drain Current(pulse) Note1	D(pulse)	±20	А
Total Power Dissipation (T _A = 25°C)	P _{T1}	2.0	W
Total Power Dissipation (Tc = 25°C)	P _{T2}	35	W
Channel Temperature	Tch	150	°C
Storage Temperature	Tstg	–55 to +150	°C
Single Avalanche Current Note2	AS	5.0	А
Single Avalanche Energy Note2	Eas	16.7	mJ

Notes1. PW \leq 10 μ s, Duty Cycle \leq 1%

2. Starting T_{ch} = 25°C, V_{DD} = 150 V, R_G = 25 Ω , V_{GS} = 20 \rightarrow 0 V

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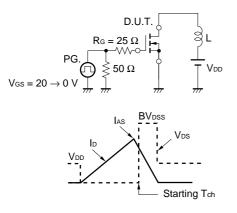


(Isolated TO-220)

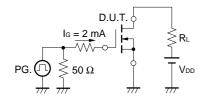
ELECTRICAL CHARACTERISTICS (TA = 25°C)

Characteristics	Symbol	Test Conditions	MIN.	TYP.	MAX.	Unit
Zero Gate Voltage Drain Current	IDSS	Vds = 600 V, Vgs = 0 V			100	μA
Gate Leakage Current	lgss	$V_{GS} = \pm 30 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$			±100	nA
Gate to Source Cut-off Voltage	V _{GS(off)}	V _{DS} = 10 V, I _D = 1 mA	2.5		3.5	V
Forward Transfer Admittance	y _{fs}	Vds = 10 V, Id = 2.5 A	1.5			S
Drain to Source On-state Resistance	RDS(on)	Vgs = 10 V, Id = 2.5 A		1.3	1.6	Ω
Input Capacitance	Ciss	V _{DS} = 10 V		750		pF
Output Capacitance	Coss	Vgs = 0 V		130		pF
Reverse Transfer Capacitance	Crss	f = 1 MHz		9.7		pF
Turn-on Delay Time	td(on)	VDD = 150 V, ID = 2.5 A		17		ns
Rise Time	tr	$V_{GS(on)} = 10 V$		3		ns
Turn-off Delay Time	td(off)	R _G = 10 Ω		37		ns
Fall Time	tr			10		ns
Total Gate Charge	QG	Vdd = 450 V		18		nC
Gate to Source Charge	QGS	Vgs = 10 V		4		nC
Gate to Drain Charge	Qgd	ID = 5.0 A		7		nC
Body Diode Forward Voltage	V _{F(S-D)}	I⊧ = 5.0 A, V₀s = 0 V		0.9		V
Reverse Recovery Time	trr	IF = 5.0 A, VGs = 0 V		1.4		μs
Reverse Recovery Charge	Qrr	di/dt = 50 A/µs		5.3		μC

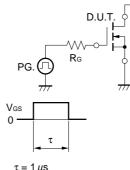
TEST CIRCUIT 1 AVALANCHE CAPABILITY



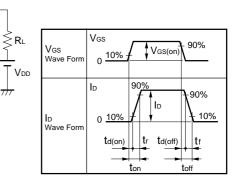
TEST CIRCUIT 3 GATE CHARGE



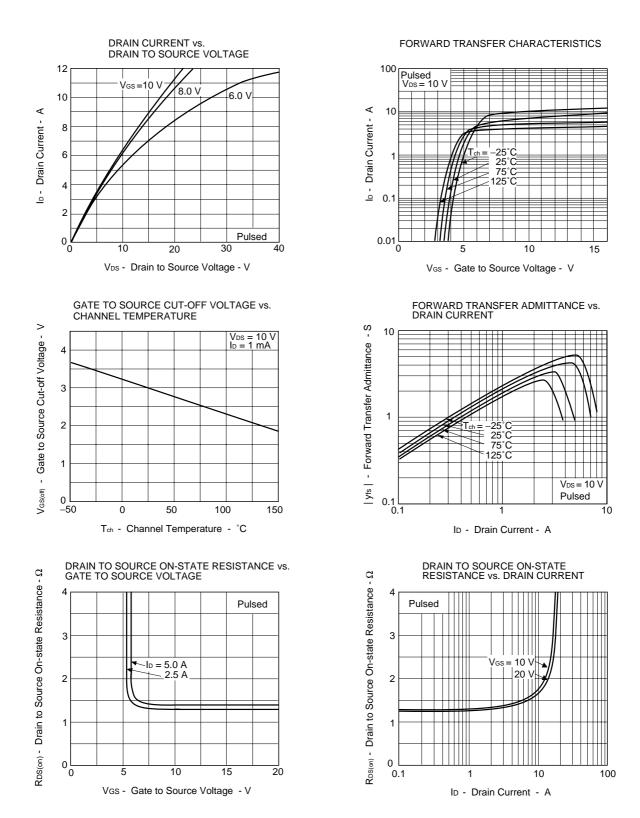
TEST CIRCUIT 2 SWITCHING TIME

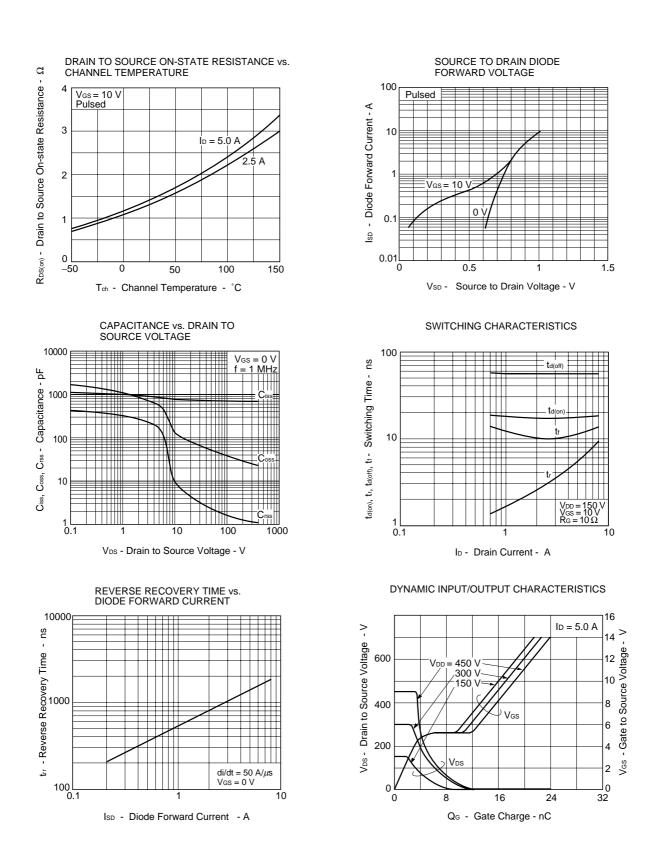


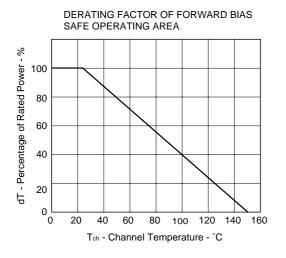


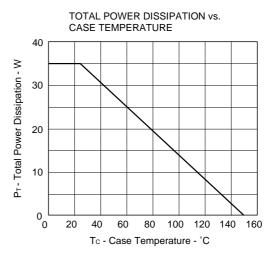


TYPICAL CHARACTERISTICS

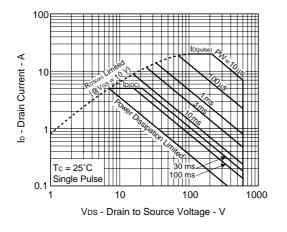


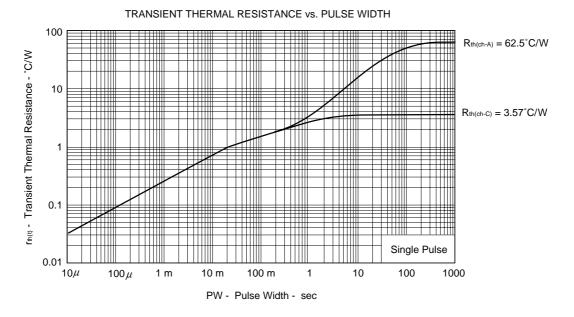


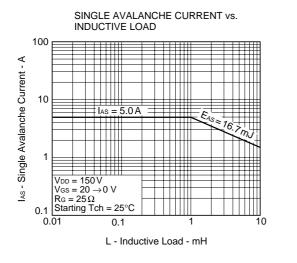


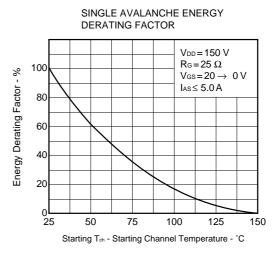


FORWARD BIAS SAFE OPERATING AREA



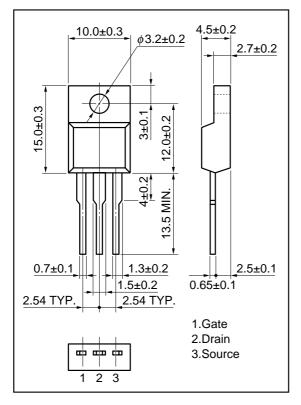




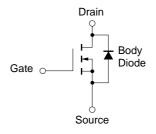


PACKAGE DRAWING(Unit: mm)

Isolated TO-220 (MP-45F)



EQUIVALENT CIRCUIT



Remark Strong electric field, when exposed to this device, can cause destruction of the gate oxide and ultimately degrade the device operation. Steps must be taken to stop generation of static electricity as much as possible, and quickly dissipate it once, when it has occurred.

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